

# BCH-381VF-12 GY - PCB header



5431851

<https://www.phoenixcontact.com/us/products/5431851>

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The figure shows the 5-position version of the product

PCB headers, nominal cross section: 1.5 mm<sup>2</sup>, color: signal gray, nominal current: 8 A, rated voltage (III/2): 160 V, contact surface: Sn, contact connection type: Pin, number of potentials: 12, number of rows: 1, number of positions: 12, number of connections: 12, product range: BCH-VF, pitch: 3.81 mm, mounting: Wave soldering, pin layout: Linear pinning, solder pin [P]: 3.5 mm, number of solder pins per potential: 1, plug-in system: BASICLINE 1,5, Pin connector pattern alignment: Standard, locking: Screw locking mechanism, mounting method: Threaded flange, type of packaging: packed in cardboard

## Your advantages

- Well-known mounting principle allows worldwide use

## Commercial data

Item number	5431851
Packing unit	100 pc
Minimum order quantity	100 pc
Note	Made to order (non-returnable)
Sales key	AA02
Product key	AABSXD
GTIN	4046356169547
Weight per piece (including packing)	3.59 g
Weight per piece (excluding packing)	3.1 g
Customs tariff number	85366930
Country of origin	CN

## Technical data

### Product properties

Product type	PCB headers
Product family	BCH-VF
Product line	COMBICON Connectors S
Type	Standard
Number of positions	12
Pitch	3.81 mm
Number of connections	12
Number of rows	1
Number of potentials	12
Mounting type	Threaded flange
Pin layout	Linear pinning
Solder pins per potential	1

### Electrical properties

#### Properties

Nominal current $I_N$	8 A
Nominal voltage $U_N$	160 V
Contact resistance	4.3 mΩ
Rated voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV

### Mounting

Mounting type	Wave soldering
Pin layout	Linear pinning

#### Flange

Tightening torque	0.3 Nm
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### Material specifications

#### Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (4 μm - 8 μm Sn)
Metal surface contact area (middle layer)	Nickel (1.5 μm - 4 μm Ni)

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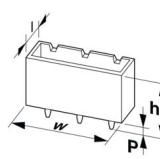
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Metal surface soldering area (top layer)	Tin (4 µm - 8 µm Sn)
Metal surface soldering area (middle layer)	Nickel (1.5 µm - 4 µm Ni)

## Material data - housing

Color (Housing)	signal gray (7004)
Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	125 °C

## Dimensions

Dimensional drawing	
Pitch	3.81 mm
Width [w]	56.11 mm
Height [h]	12.7 mm
Length [l]	7.4 mm
Installed height	9.2 mm
Solder pin length [P]	3.5 mm
Pin dimensions	0.8 x 0.8 mm

## PCB design

Hole diameter	1.2 mm
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## Mechanical tests

### Visual inspection

Specification	IEC 60512-1-1:2002-02
Result	Test passed

### Dimension check

Specification	IEC 60512-1-2:2002-02
Result	Test passed

### Resistance of inscriptions

Specification	IEC 60068-2-70:1995-12
Result	Test passed

### Polarization and coding

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Specification	IEC 60512-13-5:2006-02
Result	Test passed

## Insertion and withdrawal forces

Specification	IEC 60512-13-2:2006-02
Result	Test passed
No. of cycles	25
Insertion strength per pos. approx.	5 N
Withdraw strength per pos. approx.	3 N

## Electrical tests

### Thermal test | Test group C

Specification	IEC 60512-5-1:2002-02
Tested number of positions	16

### Insulation resistance

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 M $\Omega$

### Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	I
Comparative tracking index (IEC 60112)	CTI 600
Rated insulation voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
minimum clearance value - non-homogenous field (III/3)	1.5 mm
minimum creepage distance (III/3)	2 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.5 mm
Rated insulation voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	1.6 mm

## Environmental and real-life conditions

### Durability test

Specification	IEC 60512-9-1:2010-03
Impulse withstand voltage at sea level	2.95 kV
Contact resistance R <sub>1</sub>	4.3 m $\Omega$
Contact resistance R <sub>2</sub>	4.3 m $\Omega$
Insertion/withdrawal cycles	25
Insulation resistance, neighboring positions	> 5 M $\Omega$

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## Climatic test

Specification	EN ISO 22479:2022-06
Corrosive stress	0.2 dm <sup>3</sup> SO <sub>2</sub> on 300 dm <sup>3</sup> /40 °C/1 cycle
Thermal stress	100 °C/168 h
Power-frequency withstand voltage	1.39 kV

## Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	5g (60.1 Hz ... 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis

## Ambient conditions

Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)

## Packaging specifications

Type of packaging	packed in cardboard
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## Drawings

Dimensional drawing



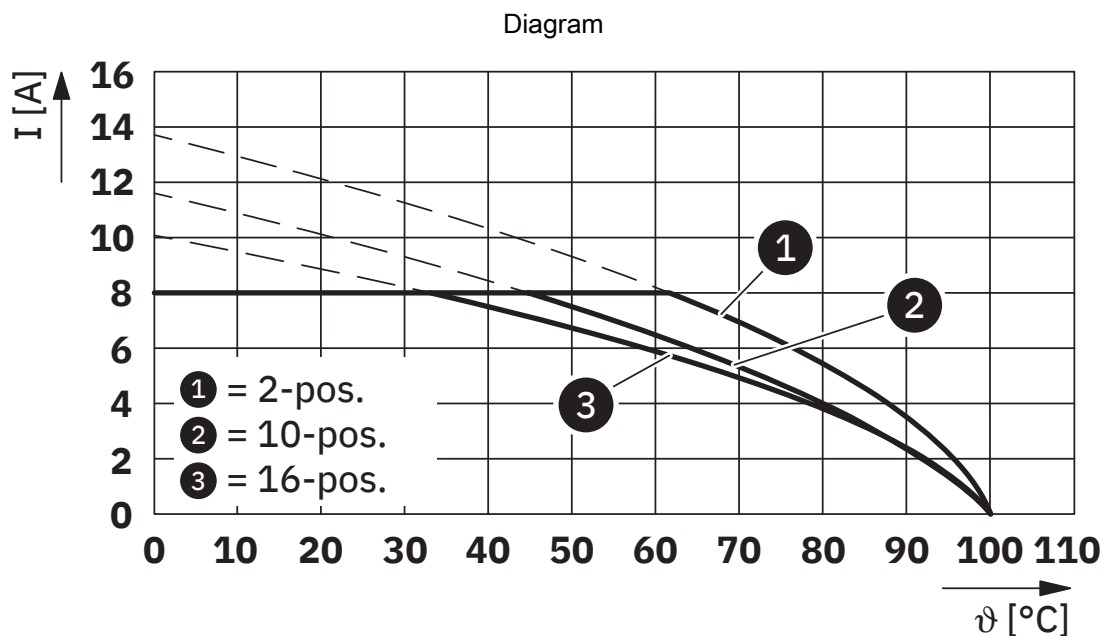
Diagram



Type: BCVP-381RF-... with BCH-381VF-...

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Type: BCP-381VF-... with BCH-381VF-...



Type: BCP-381F-... with BCH-381VF-...

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Drilling plan/solder pad geometry



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## Approvals

To download certificates, visit the product detail page: <https://www.phoenixcontact.com/us/products/5431851>

 <b>cULus Recognized</b> Approval ID: E60425-20071007				
	Nominal voltage $U_N$	Nominal current $I_N$	Cross section AWG	Cross section $\text{mm}^2$
B	250 V	8 A	-	-
D	300 V	8 A	-	-

 <b>VDE report with production monitoring</b> Approval ID: 40040694				
	Nominal voltage $U_N$	Nominal current $I_N$	Cross section AWG	Cross section $\text{mm}^2$
keine	160 V	8 A	-	0.2 - 1.5

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## Classifications

### ECLASS

ECLASS-13.0	27460201
ECLASS-15.0	27460201

### ETIM

ETIM 10.0	EC002637
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### UNSPSC

UNSPSC 21.0	39121400
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## Environmental product compliance

### EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions
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### China RoHS

Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits

### EU REACH SVHC

REACH candidate substance (CAS No.)	No substance above 0.1 wt%
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